

OLED SPECIFICATION

Model No:

RET012864QWPP3N00000

CUSTOMER:

APPROVED BY	
PCB VERSION	
DATE	

FOR CUSTOMER USE ONLY

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

Release DATE:



曜凌光電股份有限公司

Raystar Optronics, Inc. OLED Display Provider

24 June, 2015

To Whom It May Concern,

In continuing to develop and promote the strategic partnership between Microtips Technology USA (MTUSA) and Raystar Optronics, Inc (Raystar), Raystar is pleased to announce that we have entered into a business agreement with MTUSA. Raystar shall provide MTUSA datasheets, prices, samples and orders status. MTUSA shall promote the products of Raystar. In order to avoid the customer conflicts in USA market, MTUSA shall disclose the project and end customer name to Raystar.

Raystar is confident that this arrangement between our two companies will ultimately benefit the end customer.

Raystar Optronics, Inc.,

2015/07/20.

Signature

Zoe Chen

Printing Name

Microtips Technology USA

Signature

REZD Printing Name



1. Revision History

VERSION	DATE	REVISED PAGE NO.	Note
0	2014/04/21		First release
A	2015/06/11		Modify
			IDD&Brightness



Contents

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- 2. Module Classification Information
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1.General Specification

The Features is described as follow:

■ Module dimension: 73.0 × 41.86 × 3.0 mm

■ Active area: 61.41 × 30.69 mm

■ Dot Matrix: 128*64

Dot size: 0.45 × 0.45 mmDot pitch: 0.48 × 0.48 mm

■ Display Mode : Passive Matrix

■ Duty: 1/64 Duty

■ Display Color: Monochrome (White)

■ IC:SSD1325



2.Module Coding System

1	2	3	4	5	6	7	8	9	10	11	12	13
R	Е	Т	012864	Q	W	Р	Р	3	N	0	0	000

	T						
Item	Description						
1	R: Raystar Optronics Inc.						
2	E:OLED						
3	Display Type: C→C	Character Type, G→Graphic Ty	pe,T→TAB Type ,X→COG Type				
4	Dot Matrix: 128*	64					
5	Serials code						
		A: Amber	R: RED				
6	6 Emitting Color	B: Blue	Y: Yellow				
		G: Green	W: White				
7	Polarizer	P: With Polarizer; N: Without	Polarizer				
8	Display Mode	P: Passive Matrix; A: Active	Matrix				
9	Driver Voltage	3: 3.0 V; 5: 5.0V					
10	Touch Panel	N: Without touch panel; T: W	ith touch panel				
10	Touch Faller	S: Resistive touch panel					
11	Species	0:Normal, 1:Sunlight readable, 2:Transparent, 3:Flexible, 4:Lighting					
12	Grade code						
13	Serial No.	Sales code	Sales code				



3.Interface Pin Function

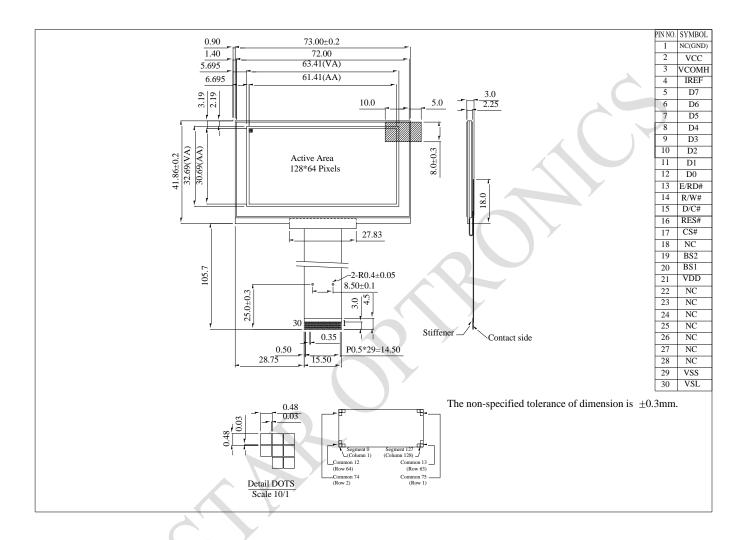
No.	Symbol	I/O	Function
1	NC(GND)		Reserved Pin (Supporting Pin) The supporting pin can reduce the influences from stresses on the function pins. This pin must be connected to external ground.
2	VCC	Р	Power Supply for OLED Panel This is the most positive voltage supply pin of the chip. It must be supplied externally.
3	VCOMH	Р	Voltage Output High Level for COM Signal This pin is the input pin for the voltage output high level for COM signals. It can be supplied externally or internally. When VCOMH is generated internally, a capacitor should be connected between this pin and VSS.
4	IREF	I	Current Reference for Brightness Adjustment This pin is segment current reference pin. A resistor should be connected between this pin and VSS. Set the current at 10µA.
5~12	D7~D0	I/O	Host Data Input/Output Bus These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK
13	E/RD#	I	Read/Write Enable or Read This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled high and the CS# is pulled low. When connecting to an 80XX-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when this pin is pulled low and CS# is pulled low.
14	R/W#	r	Read/Write Select or Write This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull it to "Low" for write mode. When 80XX interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled low and the CS# is pulled low.
15	D/C#	I	Data/Command Control This pin is Data/Command control pin. When the pin is pulled high, the input at D7~D0 is treated as display data. When the pin is pulled low, the input at D7~D0 will be transferred to the command register. For detail relationship to MCU interface signals, please refer to the Timing Characteristics Diagrams. When the pin is pulled high and serial interface mode is selected, the data at SDIN is treated as data. When it is pulled low, the data at



			SDIN will be transferred to the command register.					
			Power Reset for Controller and Driver					
16	RES#	1	This pin is reset signal input. When the pin is low, initialization of the					
			chip is executed.					
			Chip Select					
17	CS#		This pin is the chip select input. The chip is enabled for MCU					
			communication only when CS# is pulled low.					
			Reserved Pin					
18	NC		The N.C. pins between function pins are reserved for compatible and					
			flexible design.					
			Communicating Protocol Select					
19	BS2		These pins are MCU interface selection input. See the					
			following table:					
			68XX-paralle 80XX-paralle Serial					
20	BS1							
	20 501		BS1 0 1 0 BS2 1 1 0					
21	Vdd	Р	Power Supply for Logic Circuit					
22	NC		This is a voltage supply pin. It must be connected to external source.					
23	NC							
24	NC		Reserved Pin					
25	NC		The N.C. pins between function pins are reserved for compatible and					
26	NC		flexible design.					
27	NC		THOMBIO GOOIGH.					
28	NC							
	110		Ground of OLED System					
		_	This is a ground pin. It also acts as a reference for the logic pins, the					
29	Vss	Р	OLED driving voltages, and the analog circuits. It must be connected					
			to external ground.					
			Voltage Output Low Level for SEG Signal					
30	VSL	0	This pin is the output pin for the voltage output low level for SEG					
1 30	VOL		signals. A capacitor should be connected					
			between this pin and VSS.					

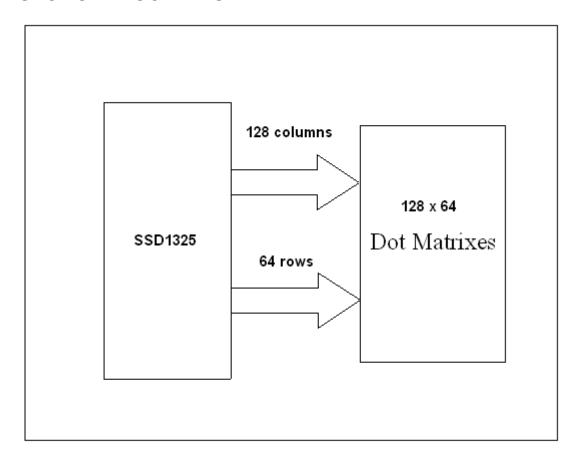


4. Counter Drawing & Block Diagram





FUNCTION BLOCK DIAGRAM



^{*}For more information, please refer to Application Note provided by Raystar Optronics.



5. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Logic	VDD	-0.3	4	V	1, 2
Supply Voltage for Display	VCC	0	15	V	1, 2
Operating Temperature	TOP	-40	+80	°C	
Storage Temperature	TSTG	-40	+80	°C	, <u>-</u>

Note 1: All the above voltages are on the basis of "VSS = 0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section6 "Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate



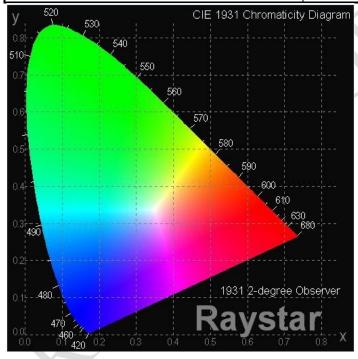
6.Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Logic	VDD	_	2.8	3.0	3.3	V
Supply Voltage for Display	VCC	_	10	12	15	٧
High Level Input	VIH	_	0.8×VDD	_	VDD	V
Low Level Input	VIL	_	0		0.2×VDD	V
High Level Output	VOH	_	0.9×VDD		VDD	V
Low Level Output	VOL	_	0	1	0.1×VDD	V
50% Check Board operating Current	ng	VCC =12V	20	22	25	mA



7. Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
View Angle	(V)θ	_	160	_	_	deg
View / trigic	(Η)φ	_	160	_	- , ,	deg
Contrast Ratio	CR	Dark	2000:1	-		
Response Time	T rise	_	_	10		μs
Tresponde Time	T fall	_	-	10		μs
Display with 50% check E	Board Brightness		60	80	_	cd/m2
CIEx(White)		(CIE1931)	0.26	0.28	0.30	_
CIEy(White)		(CIE1931)	0.30	0.32	0.34	_





8.OLED Lifetime

ITEM	Conditions	Min	Тур	Remark
Operating Life Time	Ta=25°C / Initial 50% check Board Typical Brightness Value	40,000 Hrs	50,000 Hrs	Note

Note:

- 1. Life time is defined the amount of time when the luminance has decayed to <50% of the initial value.
- 2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.
- 3. Screen saving mode will extend OLED lifetime.



9.Reliability

Content of Reliability Test

Environmenta	l Test				
Test Item	Content of Test	Test Condition	Applicable Standard		
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 240hrs	-		
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-40℃ 240hrs	4		
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80℃ 240hrs			
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-40℃ 240hrs			
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60°C,90%RH 240hrs			
Temperature Cycle	Endurance test applying the low and high temperature cycle. -40°C 25°C 80°C 30min 5min 30min 1 cycle	-40°C/80°C 100 cycles			
Mechanical Tes	st				
Vibration test	Endurance test applying the vibration during transportation and using.	10~22Hz→1.5mmp-p 22~500Hz→1.5G Total 0.5hr			
Shock test	Constructional and mechanical endurance test applying the shock during transportation.	50G Half sin wave 11 ms 3 times of each direction			
Atmospheric pressure test	Endurance test applying the atmospheric pressure during transportation by air.	115mbar 40hrs			
Others					
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time			



Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.
- 2. All-pixels-on is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/ Humidity Storage, Temperature Cycle

Evaluation criteria

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within ± 50% of initial value.

APPENDIX:

RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.



10.Inspection specification

NO	Item	Criterion			AQL		
01	Electrical	1.1 Missing vertical, horizontal segment, segment contrast					
	Testing	defect.					
		1.2 Missing character , dot or icon.					
		1.3 Display mal					
		1.4 No function	•	•	ada praduat ar	posifications	0.65
		1.5 Current con 1.6 OLED viewi	•			Decincations.	
		1.7 Mixed produ		CICC			
		1.8 Contrast det	<i>,</i> ,				
02	Black or					mm, no more than	
	white	three white or b	•	•			
	spots on	2.2 Densely spa	iced: No m	ore	than two spots	or lines within	2.5
	OLED	3mm.					
	(display only)					/	
03	OLED	3.1 Round type	: As				
	black	following drawing			SIZE	Acceptable Q	
	spots,	$\Phi = (x + y) / 2$				TY	
	white	X			Ф≦0.10	Accept no	
	spots,	→			/	dense	0.5
	contamina	— Y			0.10<	2	2.5
	tion (non-displ			,	Ф≦0.20		
	ay)				0.20 <	1	
	(4)				Ф≦0.25		
			/		0.25 < Ф	0	
		3.2 Line type : (_			
	_		Length		dth	Acceptable Q TY	
		~ ↓* <u>₩</u>			≦0.02	Accept no dense	2.5
		→ı _L +←	L≦3.0	-	02 <w≤0.03< td=""><td>2</td><td>2.5</td></w≤0.03<>	2	2.5
			L≦2.5		$03 < W \le 0.05$		
				0.0)5 <w< td=""><td>As round type</td><td></td></w<>	As round type	
04	Polarizer					_	
	bubbles	If bubbles are visible,		Si	ze Ф	Acceptable Q TY	
	7	judge using black spot			≦0.20	Accept no dense	
		specifications, not easy to find, must check in specify direction.		0.2	20<Φ≦0.50	3	2.5
				0.	50<Φ≦1.00	2	
				1.0	00<Ф	0	
				То	tal Q TY	3	



NO	Item	Criterion			AQL
05	Scratches	Follow NO.3 OLED b	lack spots, white spot	ts, contamination	
			y: Chip width z: 0 t: Glass thickness a: gth:		/
		6.1 General glass ch 6.1.1 Chip on panel s	ip : surface and crack bety X	ween panels:	
	Chipped glass		***		
		z: Chip thickness	y: Chip width	x: Chip length	
06		Z≦1/2t	Not over viewing area	x≦1/8a	2.5
		1/2t < z ≤ 2t	Not exceed 1/3k	x≦1/8a	
		⊙ If there are 2 or mo	ore chips, x is total len	gth of each chip.	
		z: Chip thickness	y: Chip width	x: Chip length	
		Z≦1/2t	Not over viewing area	x≤1/8a	
		1/2t < z ≦ 2t	Not exceed 1/3k	x≦1/8a	
		⊙ If there are 2 or mo	ore chips, x is the total	l length of each chip.	



NO	Item	Criterion	AQL		
		Symbols:			
		x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: OLED side length			
	L: Electrode pad length				
		6.2 Protrusion over terminal :			
		6.2.1 Chip on electrode pad :			
		T			
		Z			
		v: Chip width v: Chip longth 7: Chip thickness			
		$\begin{array}{ c c c c c }\hline y: Chip \ width & x: Chip \ length & z: Chip \ thickness \\\hline y \leq 0.5 mm & x \leq 1/8a & 0 < z \leq t \\\hline \end{array}$			
		6.2.2 Non-conductive portion:			
		ا سا			
	Glass crack				
06		1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	2.5		
	y T				
X					
		y: Chip width x: Chip length z: Chip			
		thickness			
		$y \le L$ $x \le 1/8a$ $0 < z \le t$			
		⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal			
		specifications.			
		⊙ If the product will be heat sealed by the customer, the alignment			
		mark not be damaged.			
	7	6.2.3 Substrate protuberance and internal crack.			
		y: width x: length			
	V	$y \le 1/3L$ $x \le a$			
		у			
	I		<u> </u>		



NO	Item	Criterion	AQL
07	Cracked glass	The OLED with extensive crack is not acceptable.	2.5
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB、COB	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down. 	2.5 2.5 0.65 2.5 2.5 0.65 2.5
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65



NO	Item	Criterion	AQL
12	General appearance	 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. 12.9 OLED pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product specification sheet. 	2.5 0.65 2.5 2.5 2.5 2.5 0.65 0.65 0.65



Check Item	Classification	Criteria
No Display	Major	
Missing Line	Major	
Pixel Short	Major	
Darker Short	Major	
Wrong Display	Major	
Un-uniform B/A x 100% < 70% A/C x 100% < 70%	Major	A Normal B Dark Pixel C Light Pixel



11.Precautions in use of OLED Modules

- (1) Avoid applying excessive shocks to module or making any alterations or modifications to it.
- (2) Don't make extra holes on the printed circuit board, modify its shape or change the components of OLED display module.
- (3) Don't disassemble the OLED display module.
- (4) Don't operate it above the absolute maximum rating.
- (5) Don't drop, bend or twist OLED display module.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.
- (8) It's pretty common to use "Screen Saver" to extend the lifetime and Don't use fix information for long time in real application.
- (9) Don't use fixed information in OLED panel for long time, that will extend "screen burn" effect time..
- (10) Raystar has the right to change the passive components, including R2and R3 adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (11) Raystar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Raystar have the right to modify the version.)

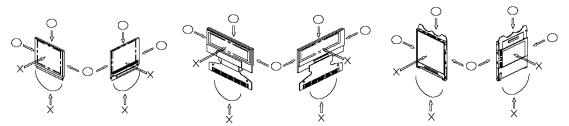
11.1 Handling Precautions

- (1) Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
- * Scotch Mending Tape No. 810 or an equivalent

Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent Also, pay attention that the following liquid and solvent may spoil the polarizer:

- * Water
- * Ketone
- * Aromatic Solvents
- (6) Hold OLED display module very carefully when placing OLED display module into the System housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.





- (7) Do not apply stress to the LSI chips and the surrounding molded sections.
- (8) Do not disassemble nor modify the OLED display module.
- (9) Do not apply input signals while the logic power is off.
- (10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.
- * Be sure to make human body grounding when handling OLED display modules.
- * Be sure to ground tools to use or assembly such as soldering irons.
- * To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
- * Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.
- (11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5.
- (12) If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

11.2 Storage Precautions

- (1) When storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps. And, also, avoiding high temperature and high humidity environment or low temperature (less than 0°C) environments. (We recommend you to store these modules in the packaged state when they were shipped from Raystar Optronics Inc. At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.
- (2) If electric current is applied when water drops are adhering to the surface of the OLED display module, when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.



11.3 Designing Precautions

- (1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen.
- (2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- (3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- (4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- (5) As for EMI, take necessary measures on the equipment side basically.
- (6) When fastening the OLED display module, fasten the external plastic housing section.
- (7) If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module. Connection (contact) to any other potential than the above may lead to rupture of the IC.



Page: 1

Module Sample Estimate Feedback Sheet					
Module Number :					
1 · Panel Specification :					
1. Panel Type:	□ Pass	□NG ,			
2. Numbers of Pixel:	□ Pass	□NG ,			
3. View Area:	□ Pass	□NG ,			
4. Active Area:	□ Pass	□NG ,			
5.Emitting Color:	□ Pass	□NG ,			
6.Uniformity:	□Pass	□NG ,			
7.Operating	□ Pass	□NG ,			
Temperature :		, , , , , , , , , , , , , , , , , , ,			
8.Storage Temperature:	□ Pass	□NG ,			
9.Others:					
2 · Mechanical Specificat	ion :				
1. PCB Size:	□Pass	□NG ,			
2.Frame Size :	□Pass	□NG ,			
3.Materal of Frame:	□Pass	□NG ,			
4.Connector Position:	□Pass	□NG ,			
5.Fix Hole Position:	□Pass	□NG ,			
6. Thickness of PCB:	□Pass	□NG ,			
7. Height of Frame to	□Pass	□NG ,			
PCB:					
8.Height of Module:	□Pass	□NG ,			
9.Others:	□Pass	□NG ,			
3 · Relative Hole Size :					
1.Pitch of Connector:	□Pass	□NG ,			
2.Hole size of	□Pass	□NG ,			
Connector:					
3.Mounting Hole size :	□Pass	□NG ,			
4.Mounting Hole Type:	□Pass	□NG ,			
5.Others:	□Pass	□NG .			

>> Go to page 2 <<



	Page: 2			
Module Number :				
4 · Electronic Characteristics of Module :				
□Pass	□NG ,			
□Pass	□NG ,			
□Pass	□NG ,			
□Pass	□NG ,			
□Pass	□NG ,			
□Pass	□NG ,			
□Pass	□NG ,			
□Pass	□NG ,			
Sales signature : Customer Signature : <u>Date :</u>				
	□Pass □Pass □Pass □Pass □Pass □Pass □Pass □Pass			

X-ON Electronics

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